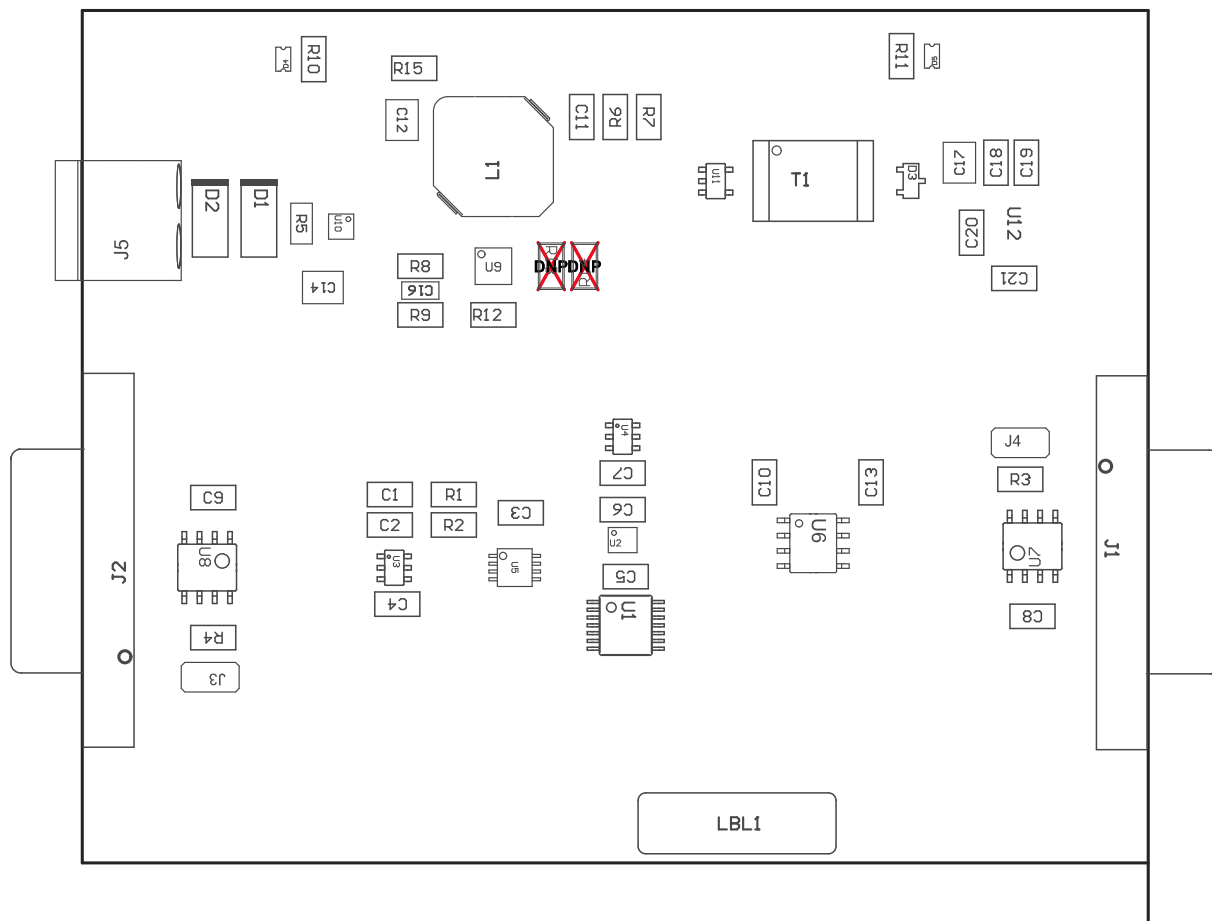


Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

Z22 ■ This Assembly Note will show in the PcbDoc and associated outputs

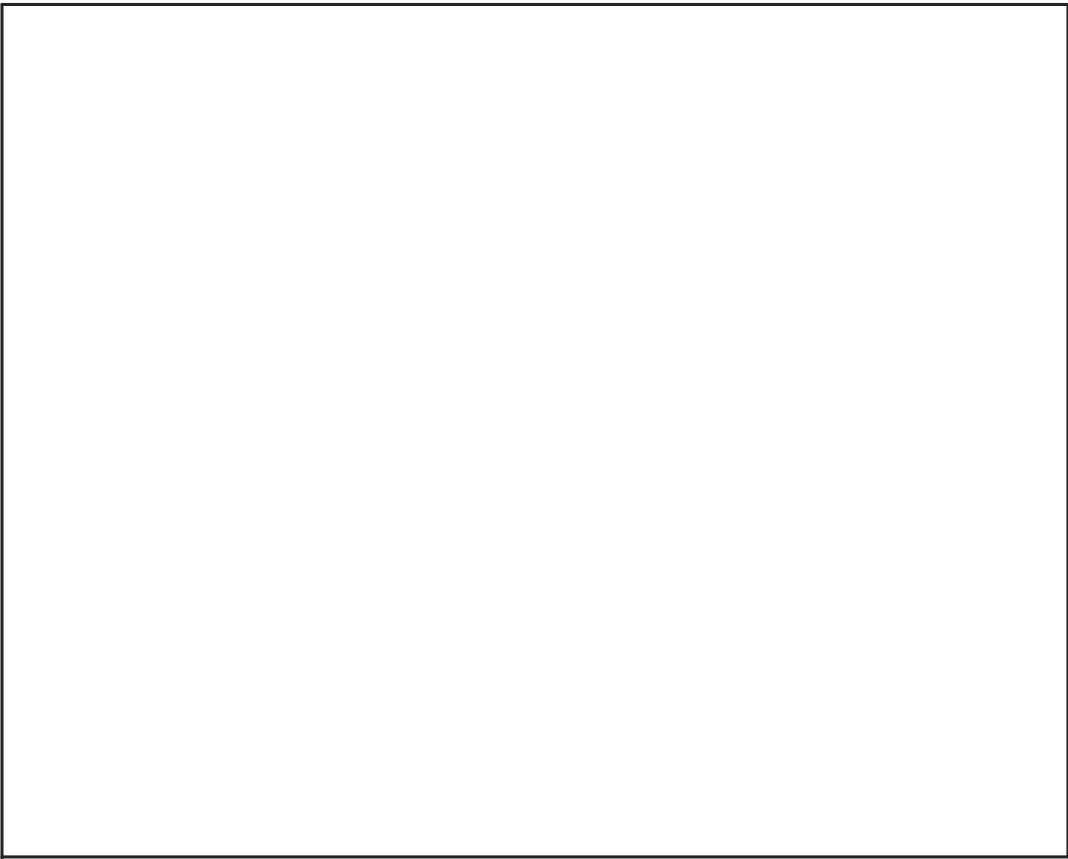
Z23 ■ This Assembly Note will show in the PcbDoc and associated outputs

Z24 ■ This Assembly Note will show in the PcbDoc and associated outputs



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01487	REV: E2	SUN REV: Not In VersionControl
	TID #: TIDA-01487		
PLOT NAME = Top Assembly Drawing	GENERATED : 3/12/2018	1:12:08 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-01487	REV: E2	SUN REV: Not In VersionControl
	TID #: TIDA-01487		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 3/12/2018	1:12:09 PM	TEXAS INSTRUMENTS

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